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(12) **United States Design Patent**  
**Nolan et al.**

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(54) **POLYHEDRON SENSOR ENCLOSURE**

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(US)

(\*\*) Term: **15 Years**

(21) Appl. No.: **29/505,641**

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(51) **LOC (10) Cl.** ..... **14-02**

(52) **U.S. Cl.**  
USPC ..... **D14/440**

(58) **Field of Classification Search**  
USPC ..... D14/250, 440, 447; 206/45.23, 320,  
206/45.2; 361/679.55; 294/25; 224/218,  
224/222; D9/414; D3/29; D11/3  
CPC .... G06F 1/1628; G06F 1/1667; G06F 1/1626;  
A47B 23/044; H04B 1/3888; A45C 11/00  
See application file for complete search history.

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(57) **CLAIM**

The ornamental design for a polyhedron sensor enclosure, as shown and described.

**DESCRIPTION**

FIG. 1 is a perspective view of a closed polyhedron sensor enclosure.

FIG. 2 is a front view thereof;

FIG. 3 is a back view thereof;

FIG. 4 is a perspective view thereof indicating a cross section;

FIG. 5 is a cross sectional view of the interior space of a closed polyhedron sensor enclosure.

FIG. 6. is a perspective view of a partially closed polyhedron sensor enclosure.

FIG. 7 is a perspective view of an opened polyhedron sensor enclosure.

FIG. 8 is a first side view thereof;

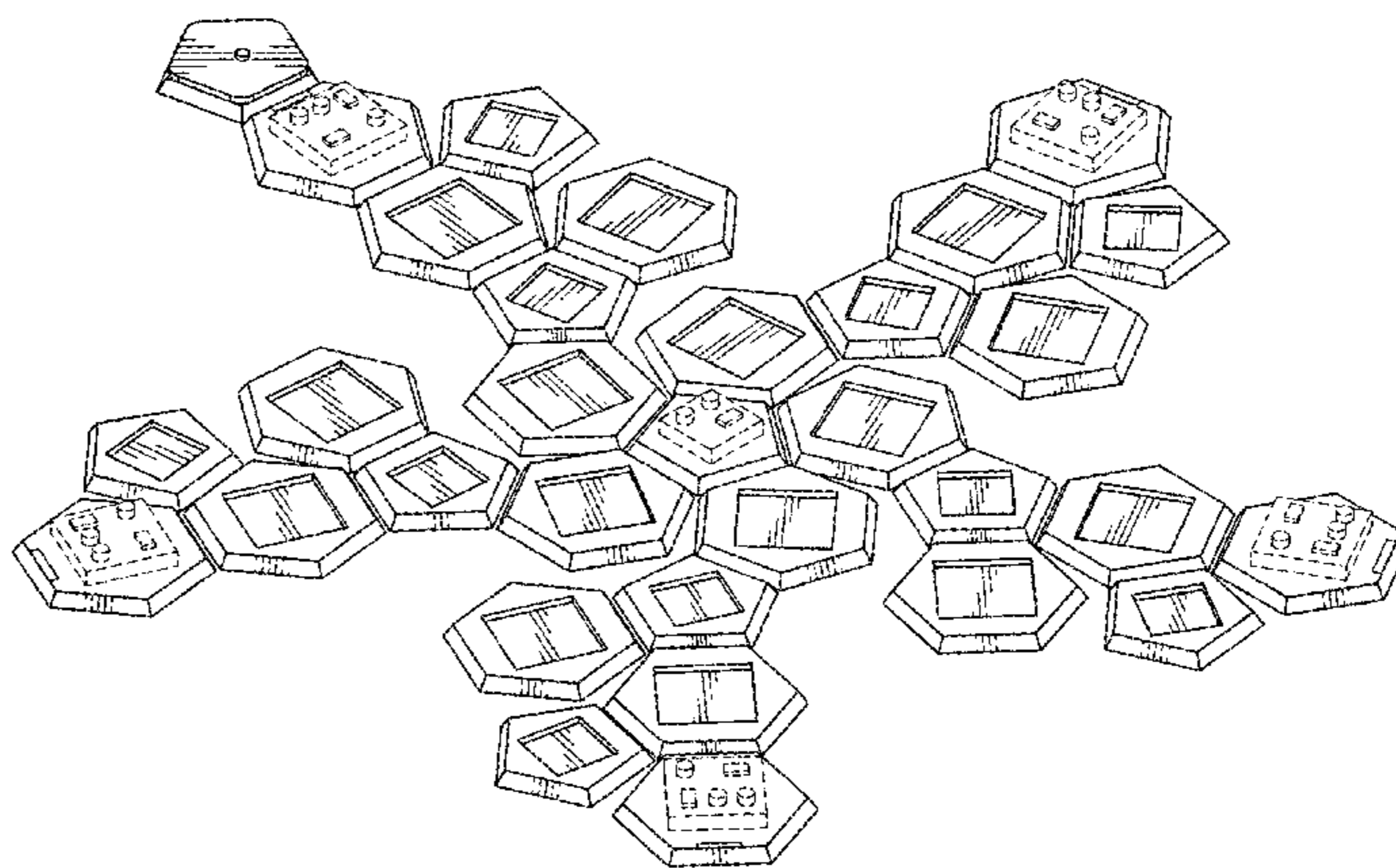
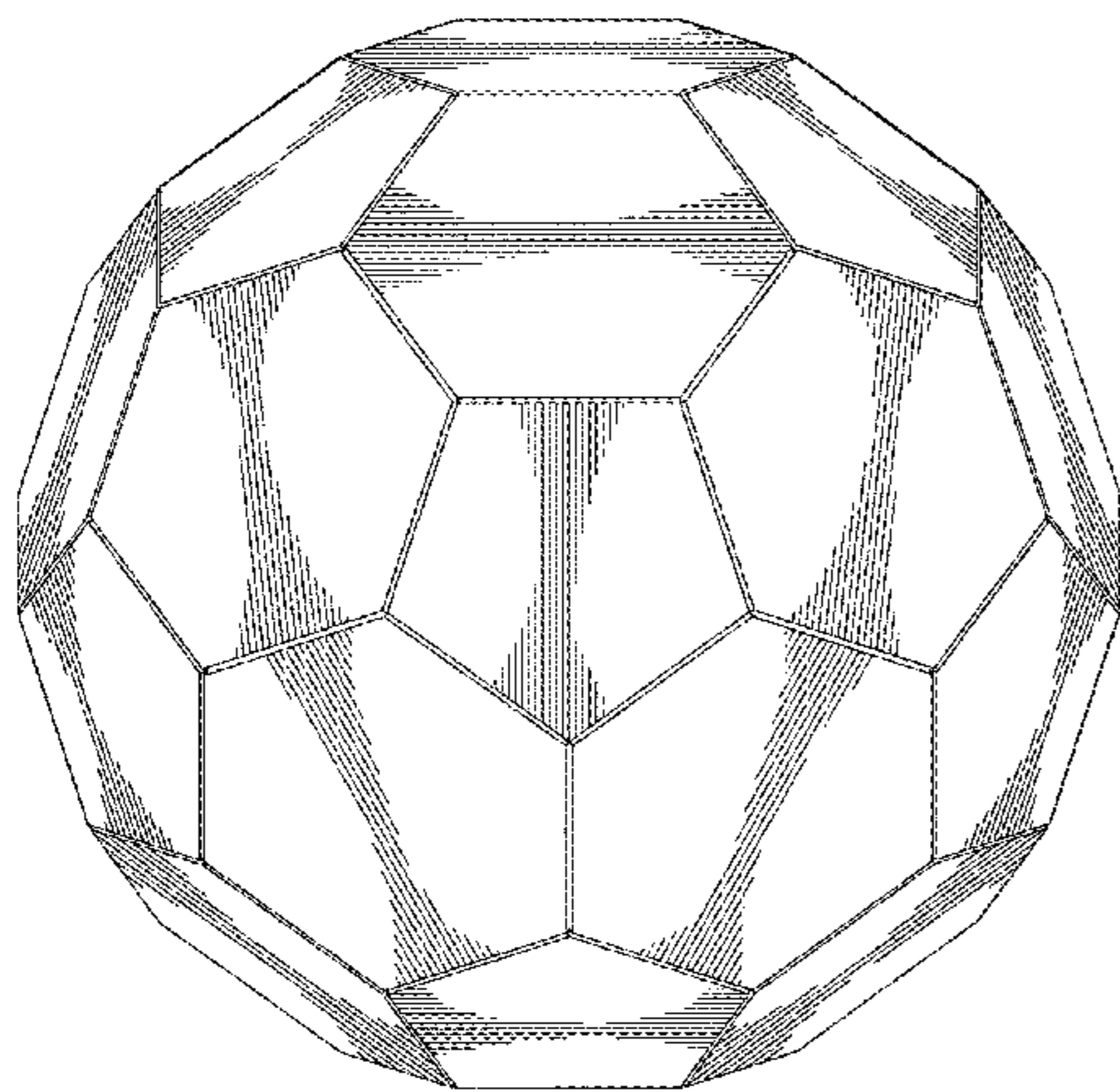
FIG. 9 is a second side view thereof;

FIG. 10 is a top view thereof; and,

FIG. 11 is a bottom view thereof.

The broken lines represent environment and form no part of the claim.

**1 Claim, 10 Drawing Sheets**



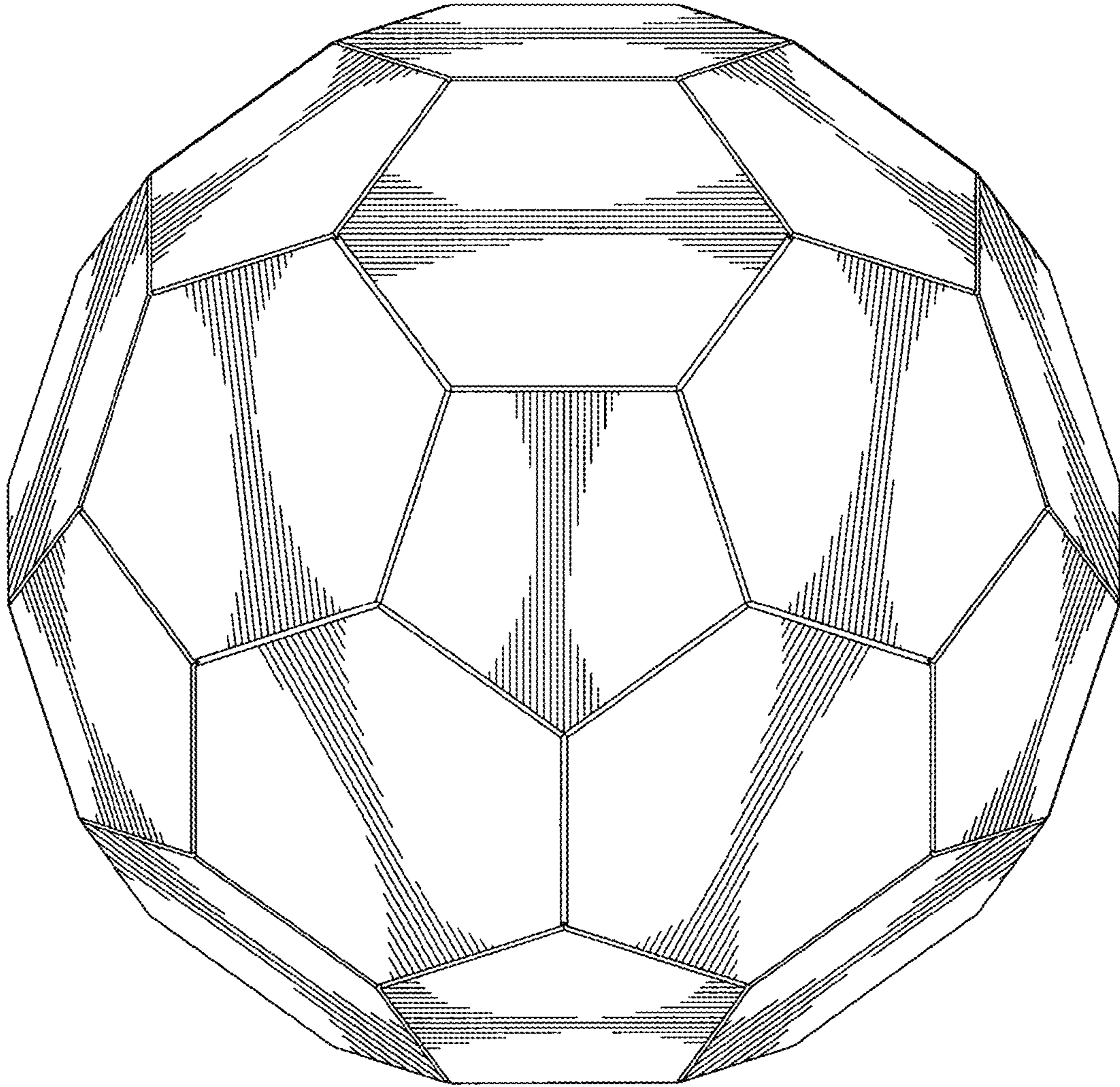


FIG. 1

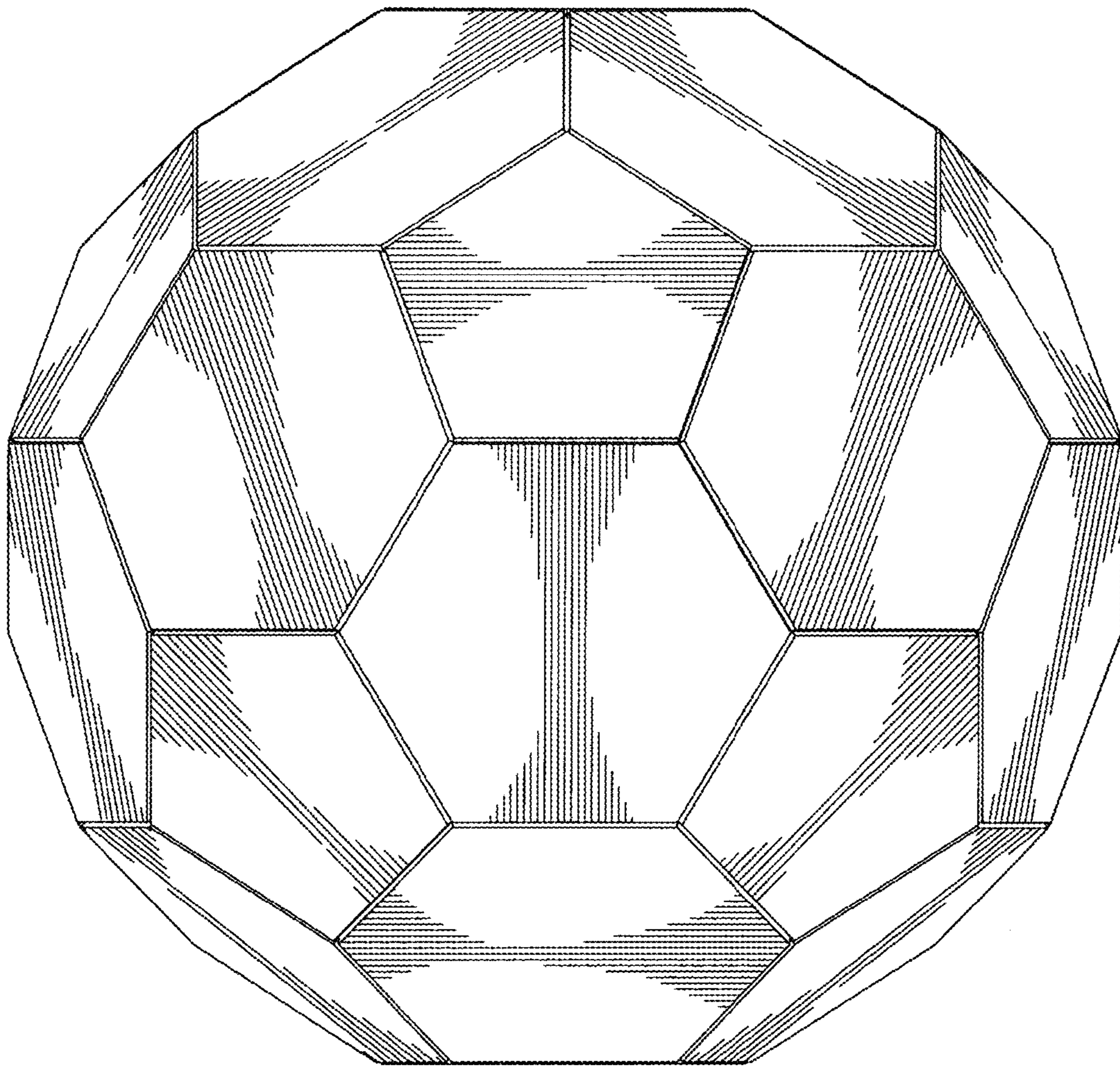


FIG. 2

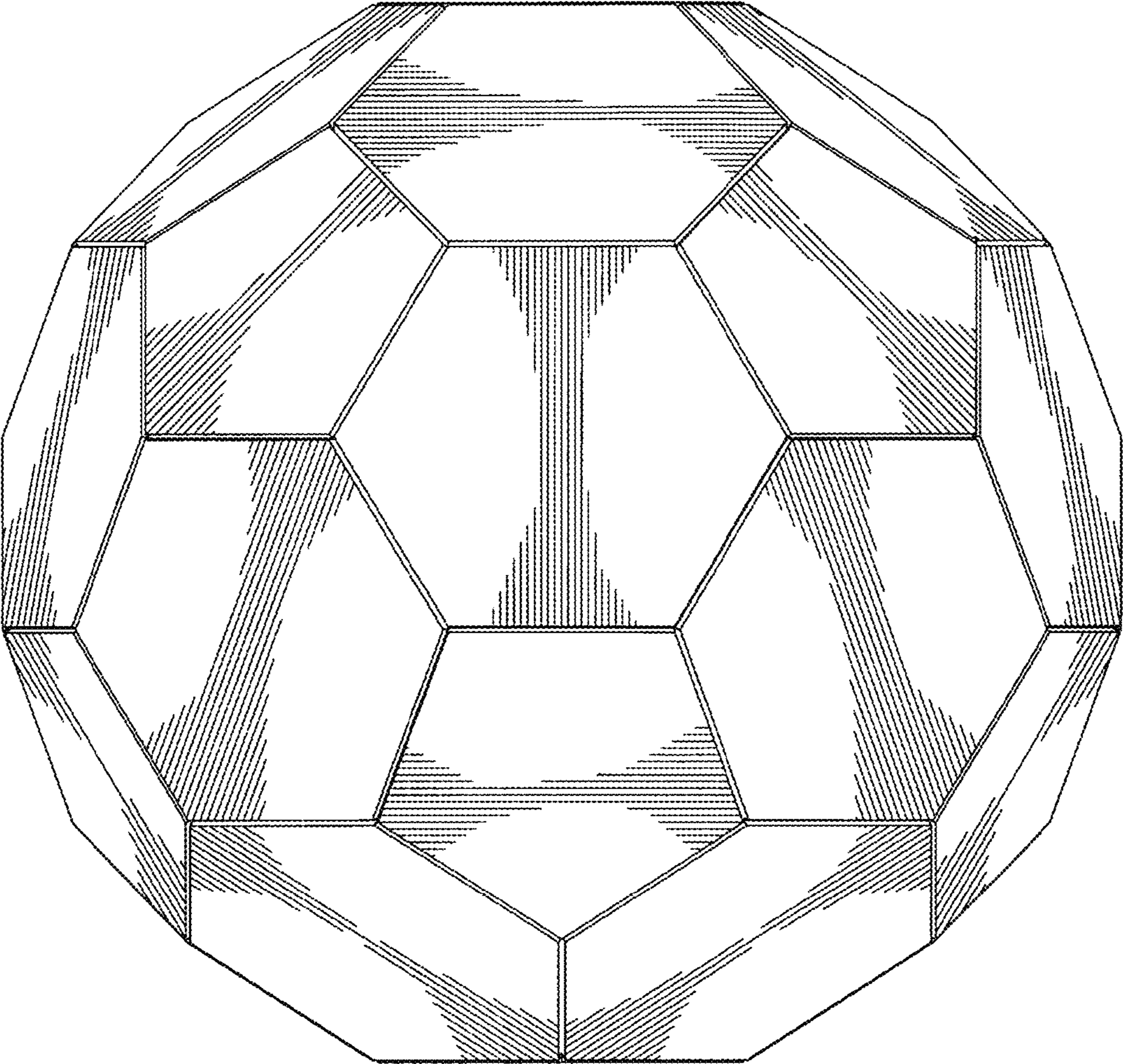


FIG. 3

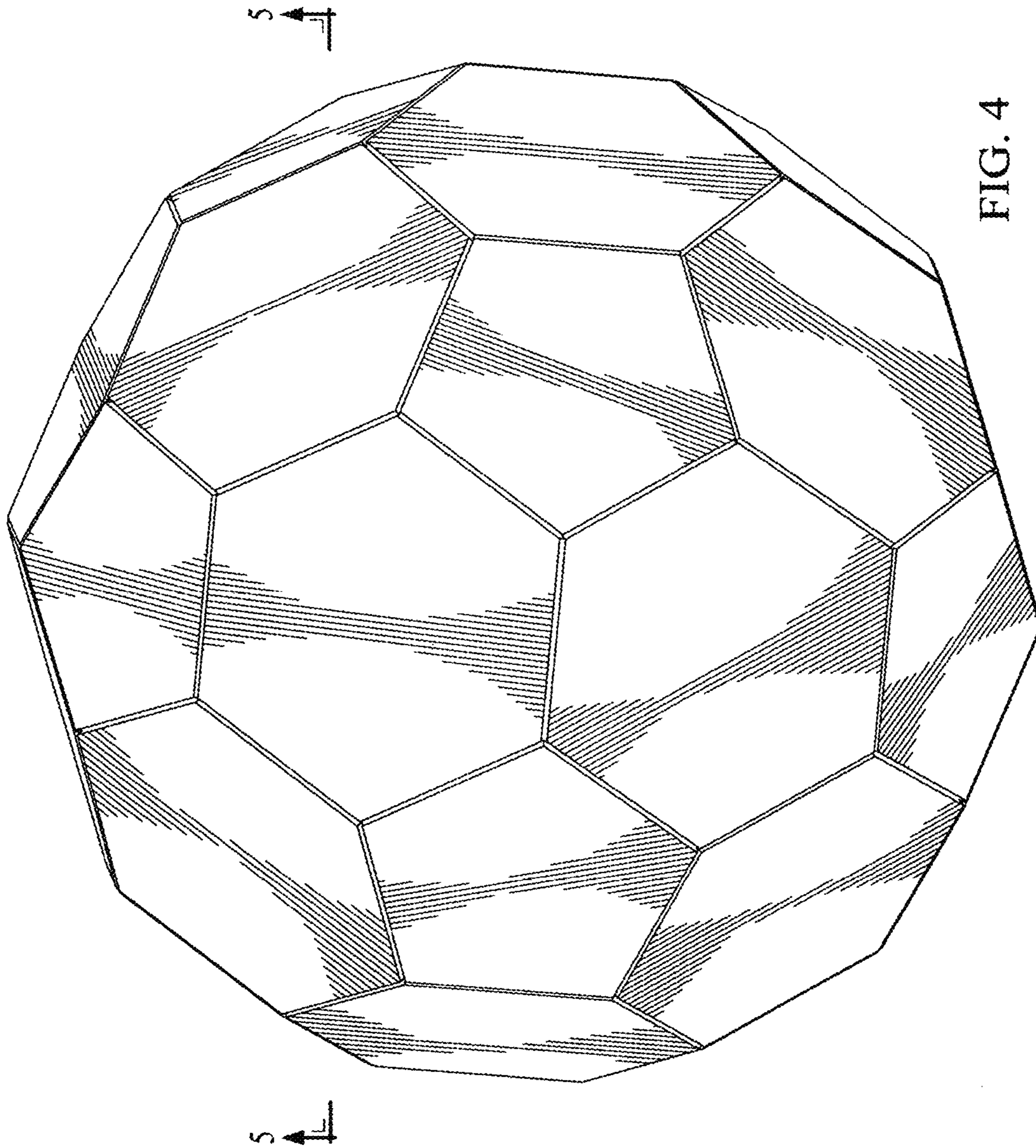


FIG. 4

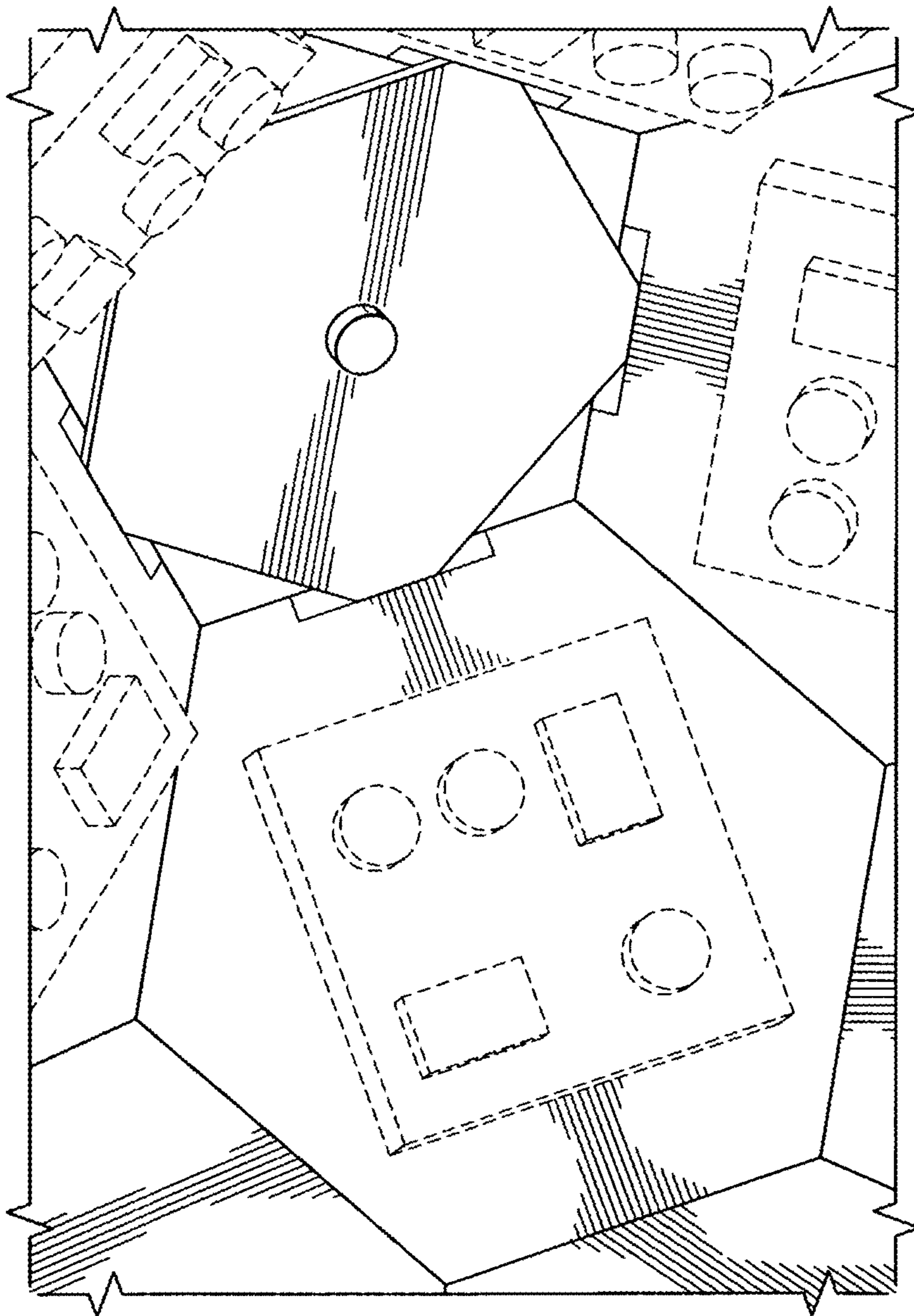


FIG. 5

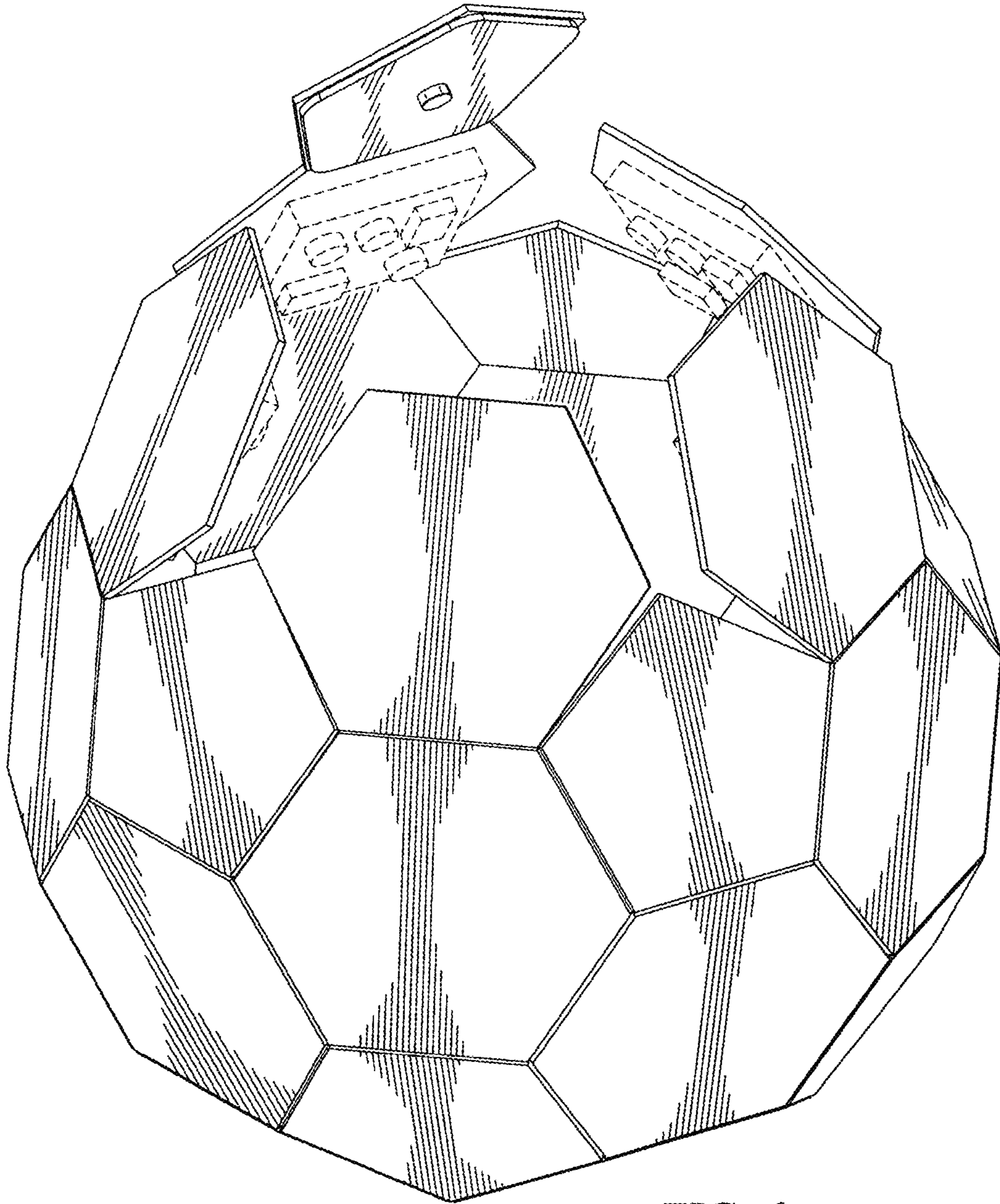


FIG. 6

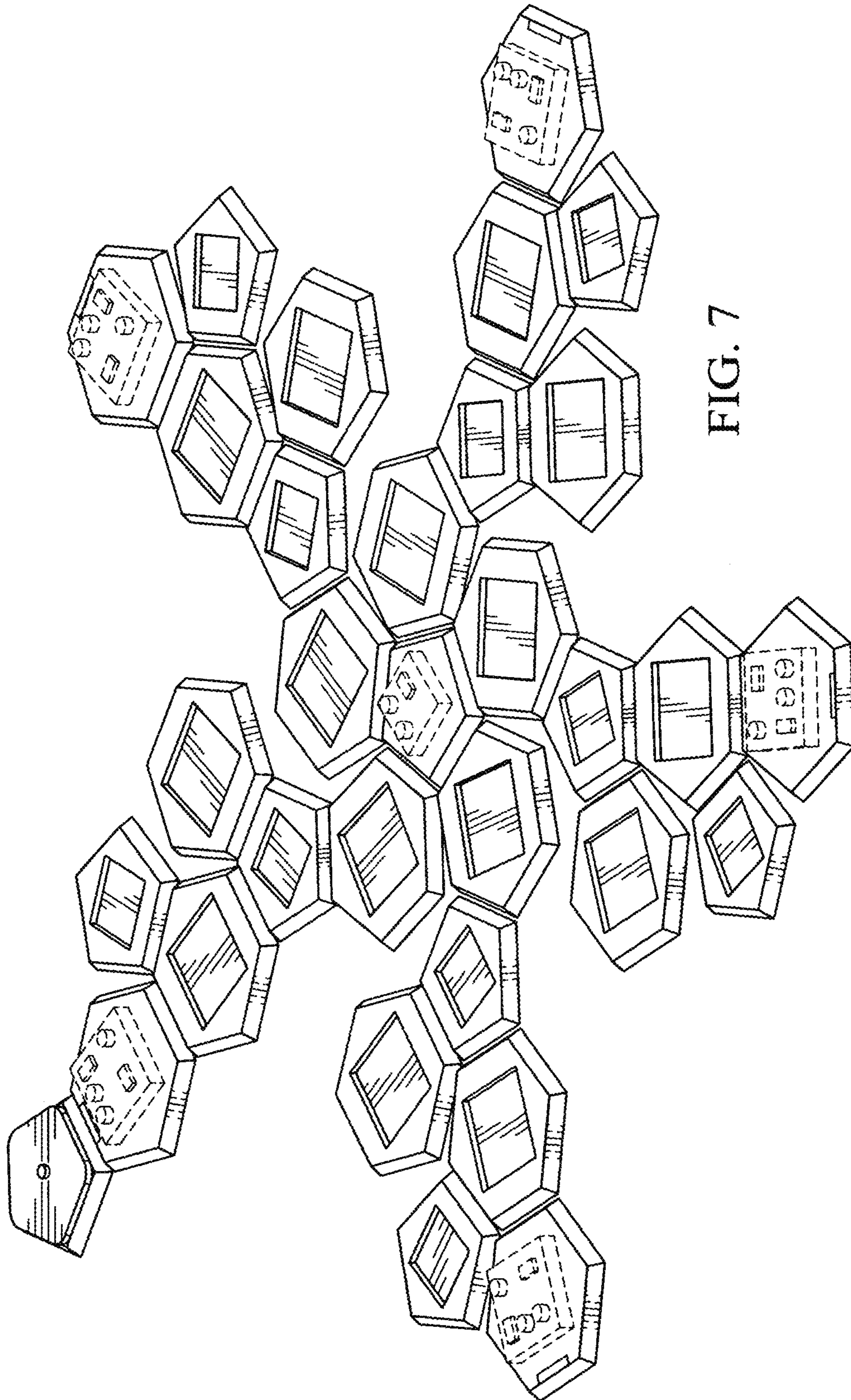


FIG. 7



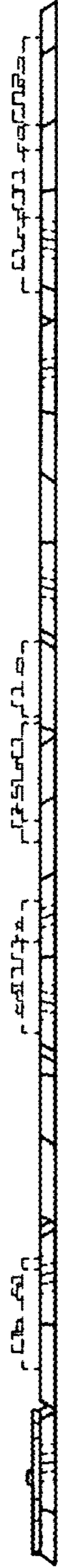


FIG. 8

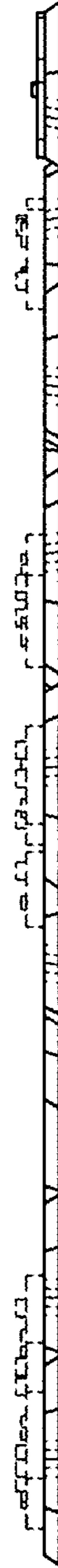


FIG. 9

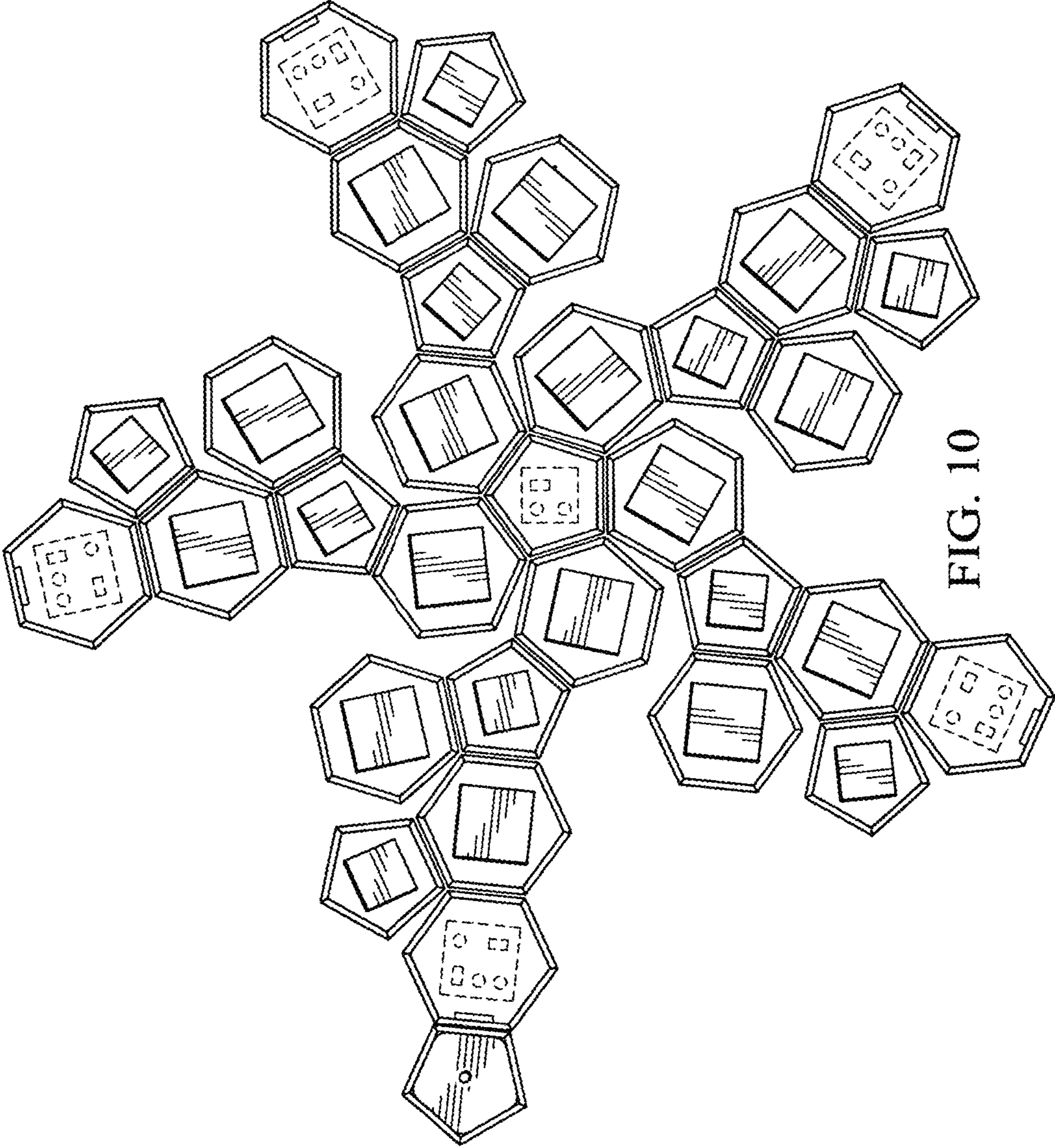


FIG. 10

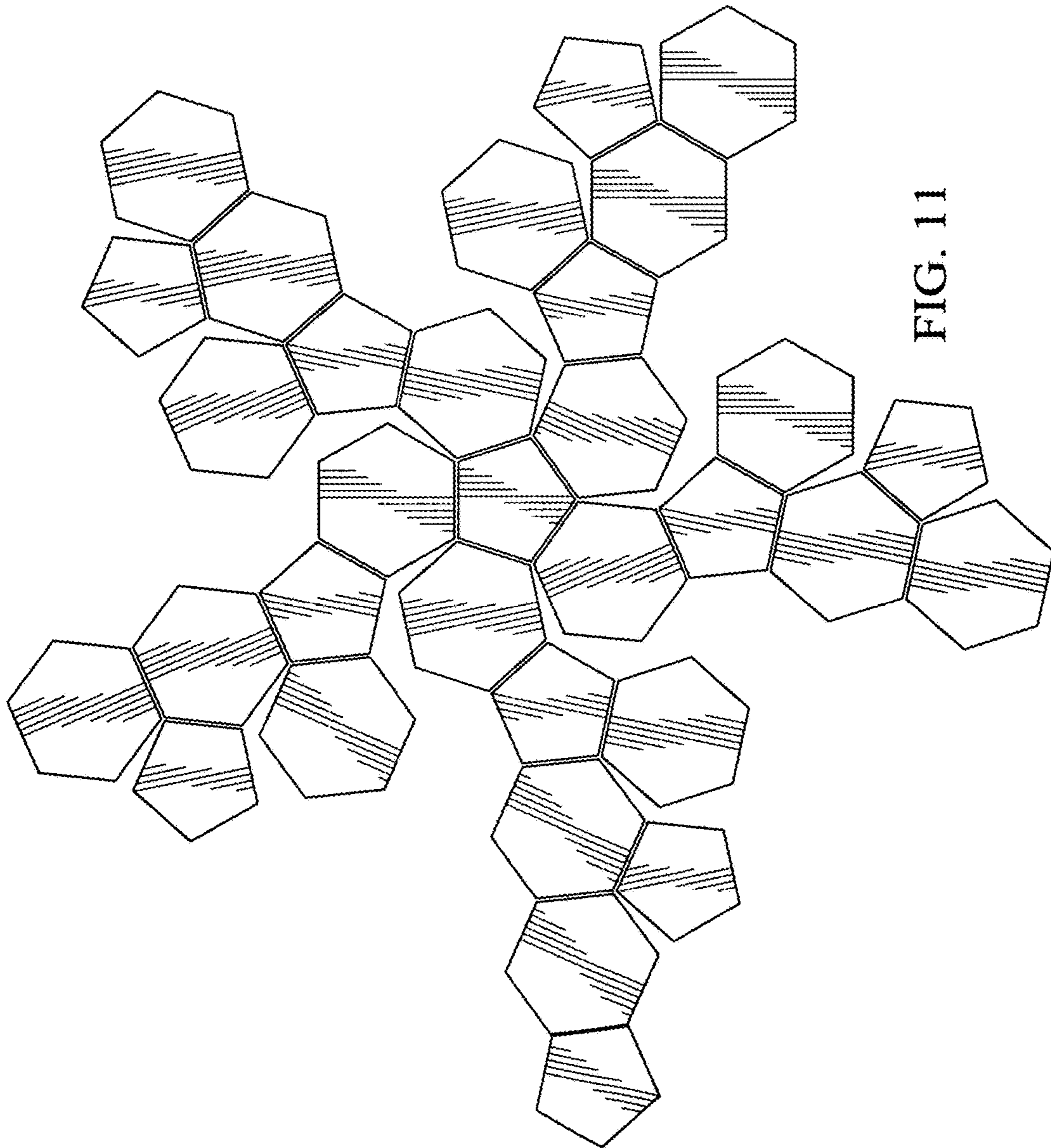


FIG. 11